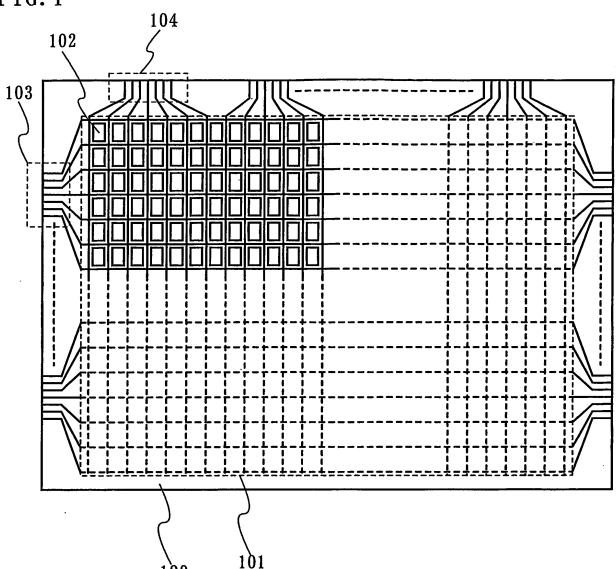
FIG. 1



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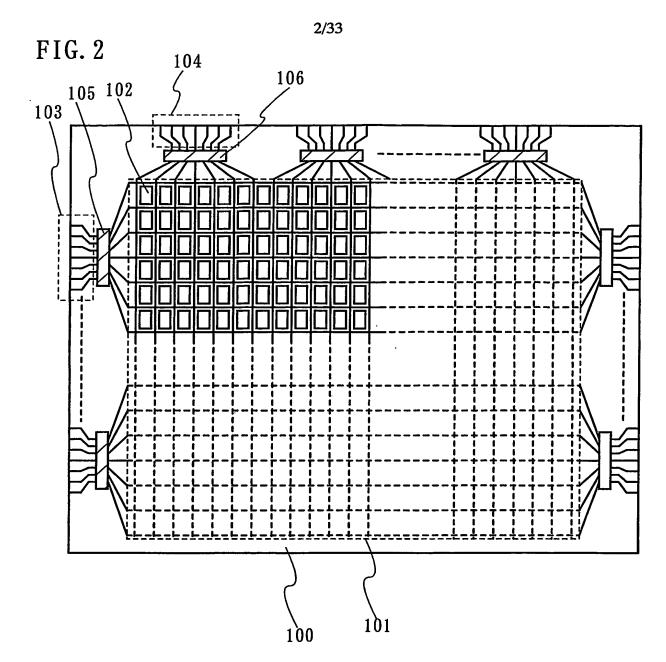
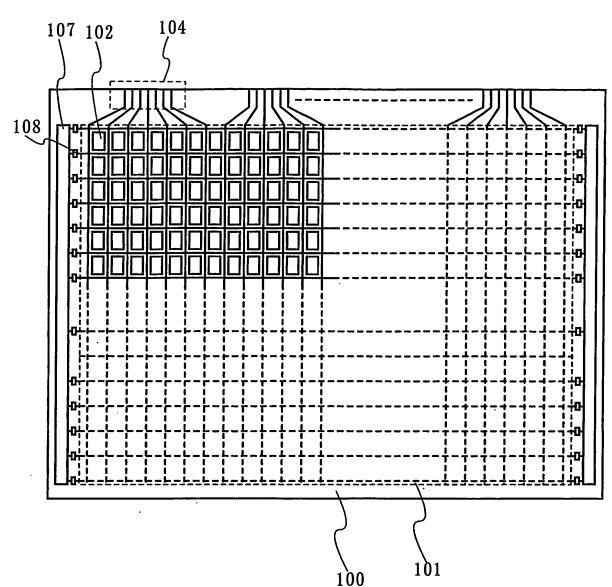


FIG. 3



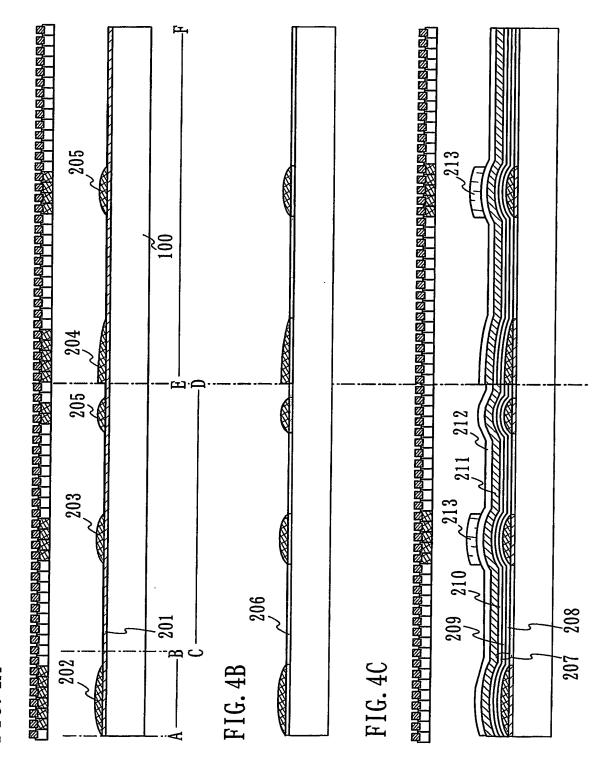
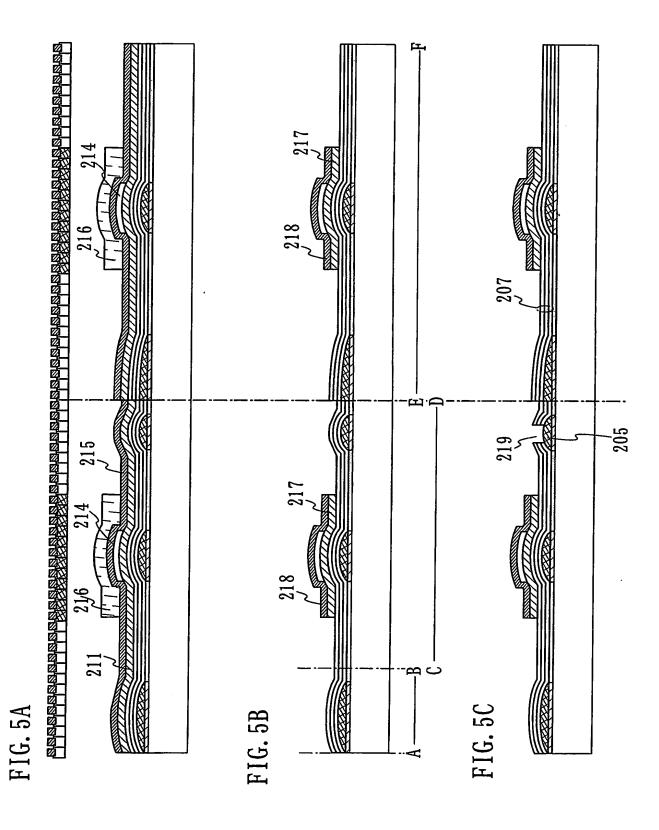


FIG. 4

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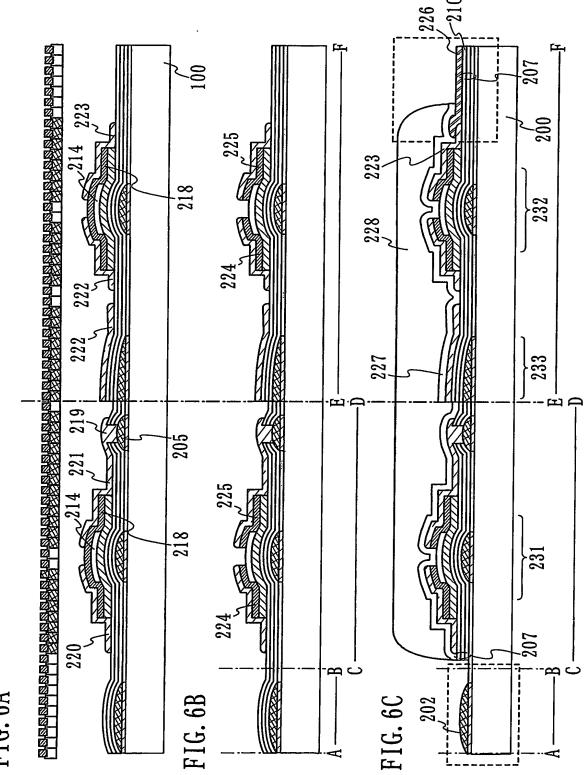
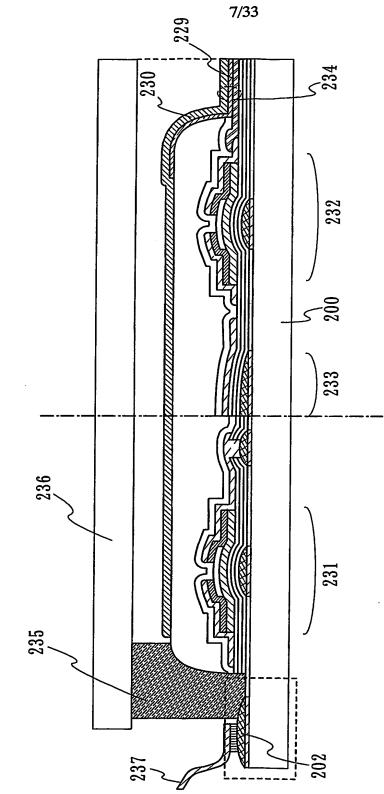


FIG. 6/



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FIG. 8

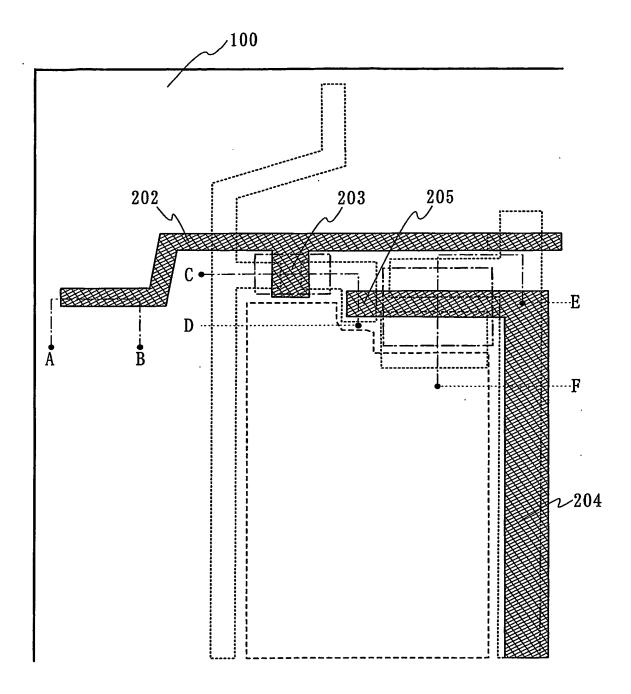
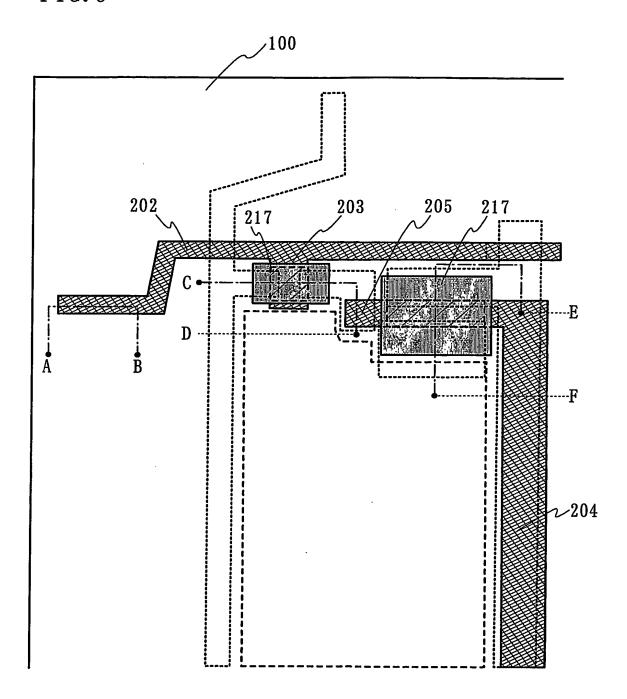


FIG. 9



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FIG. 10

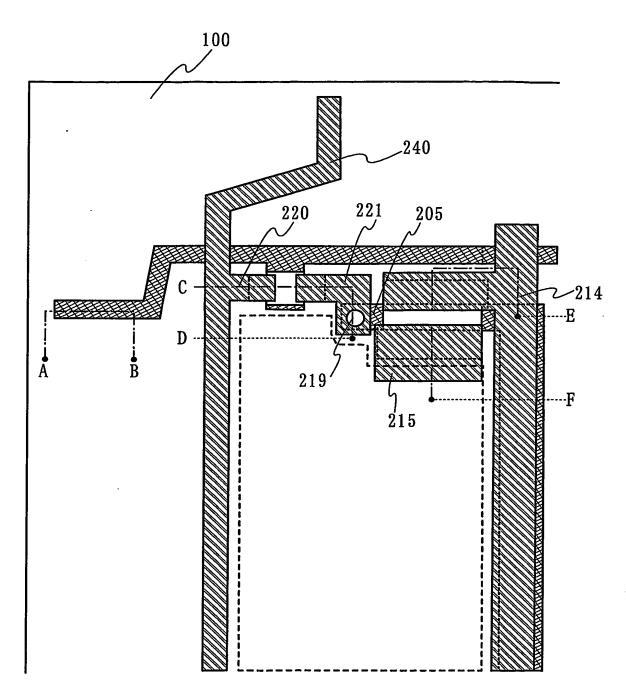
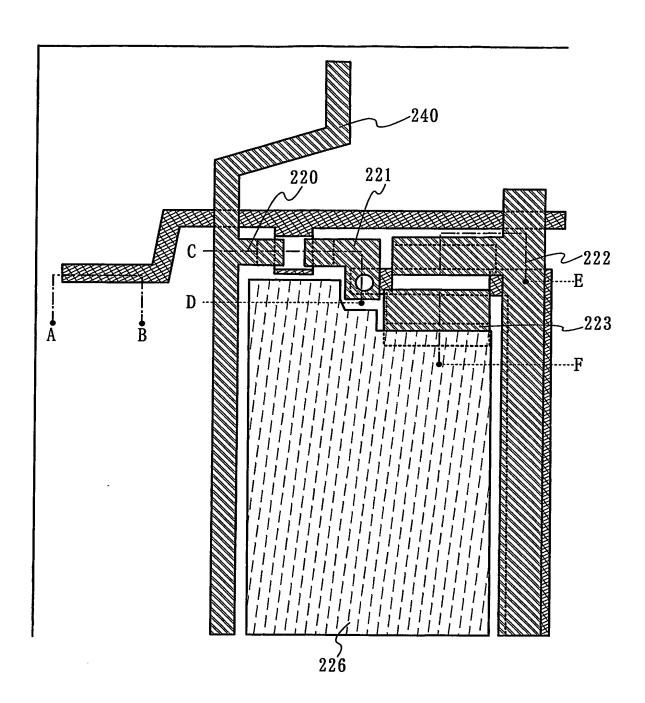
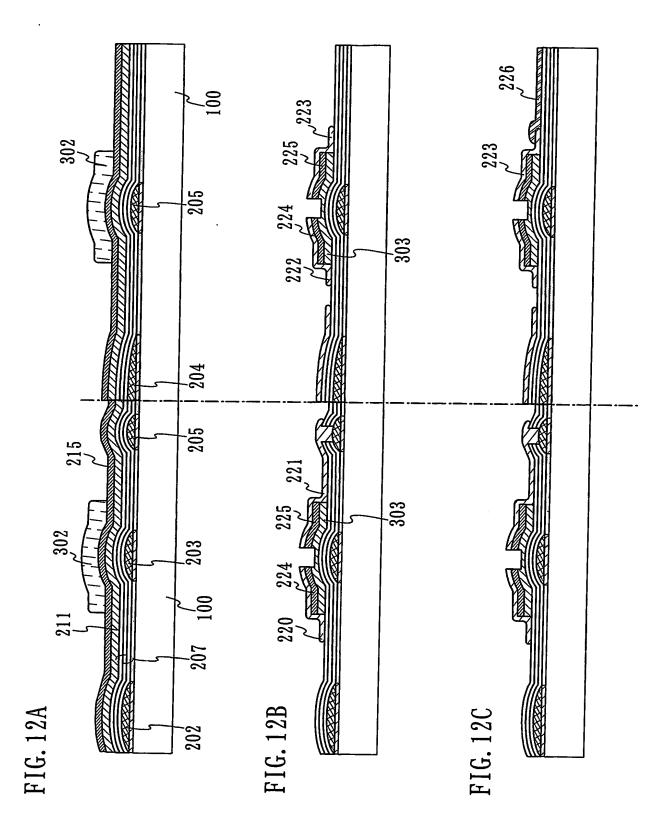
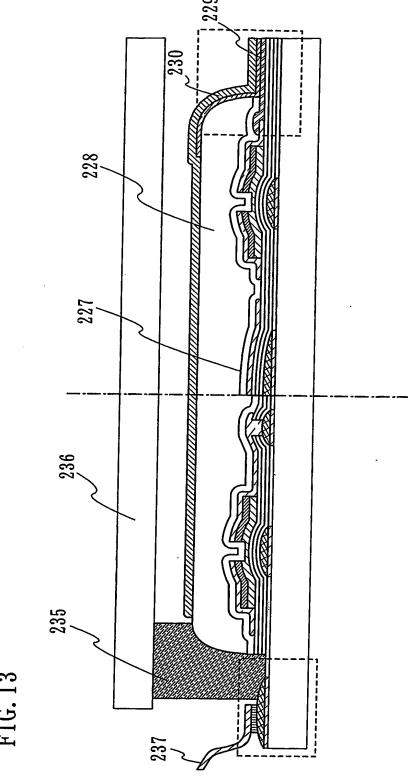


FIG. 11







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FIG. 14

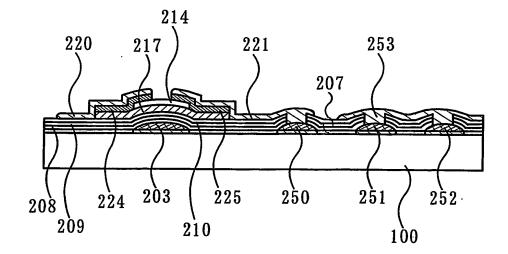


FIG. 15

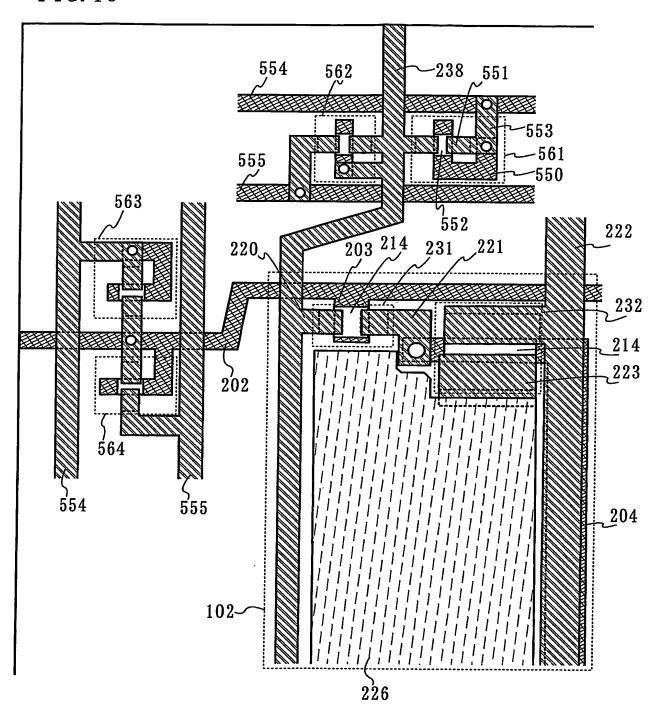
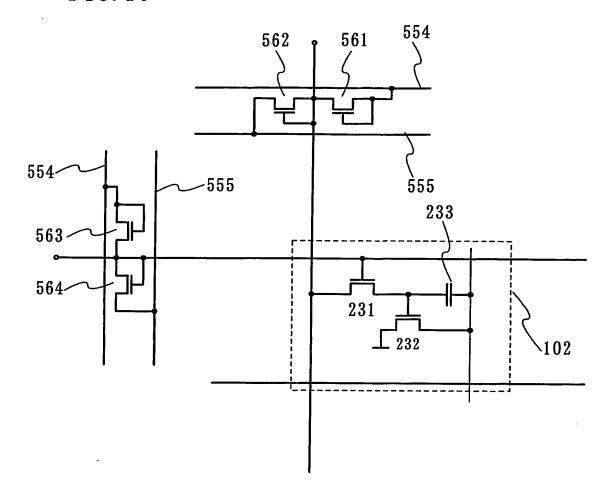
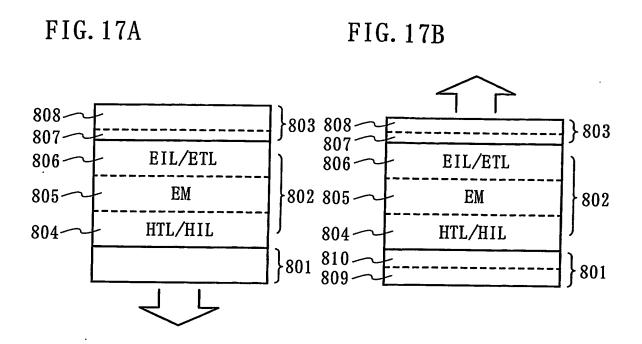


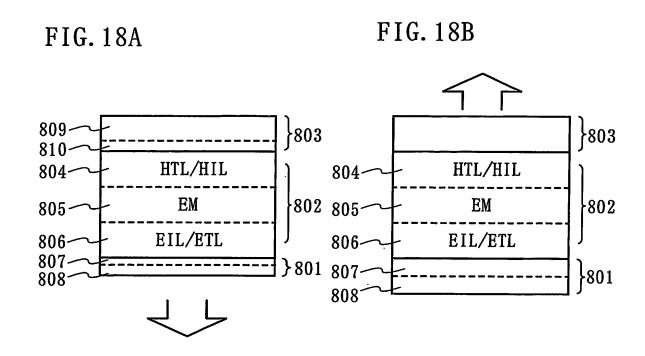
FIG. 16



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FIG. 20A

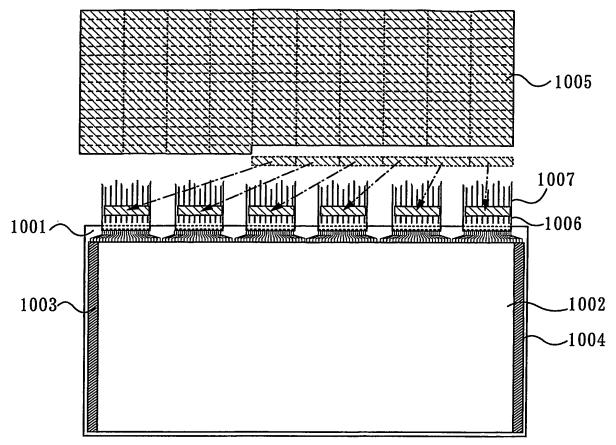
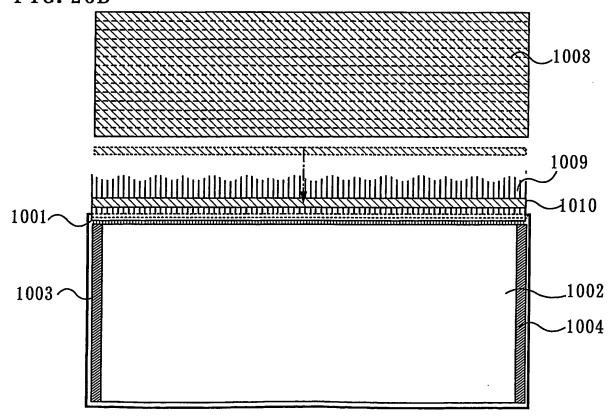


FIG. 20B



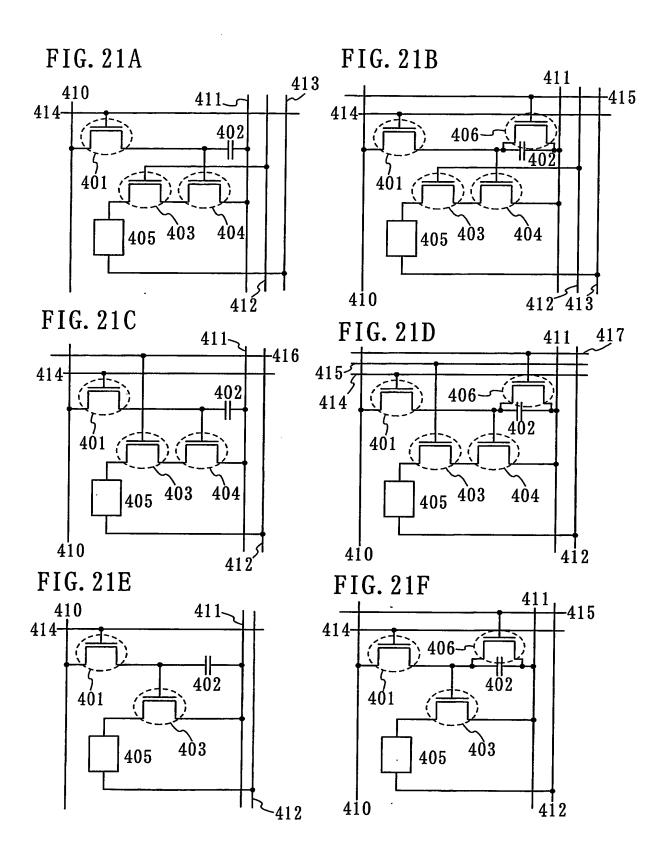


FIG. 22

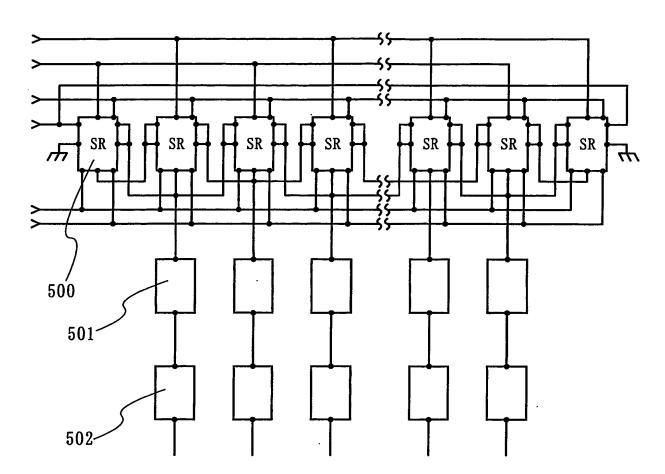


FIG. 23

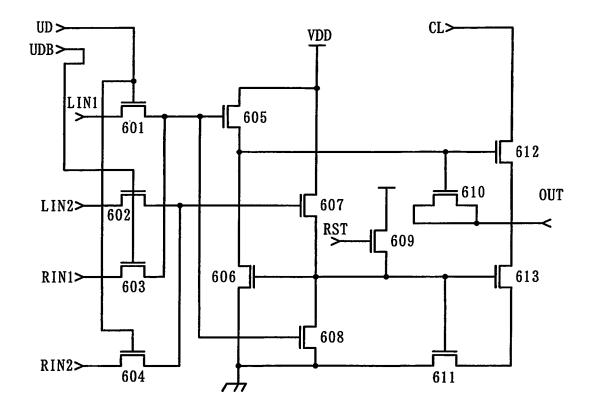


FIG. 24

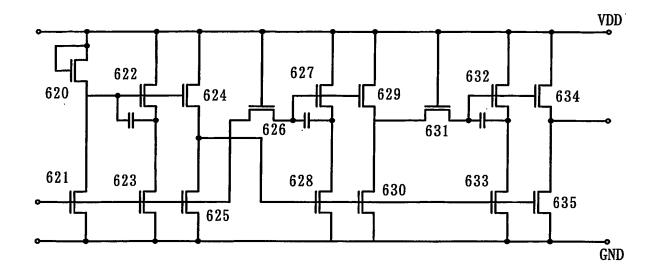
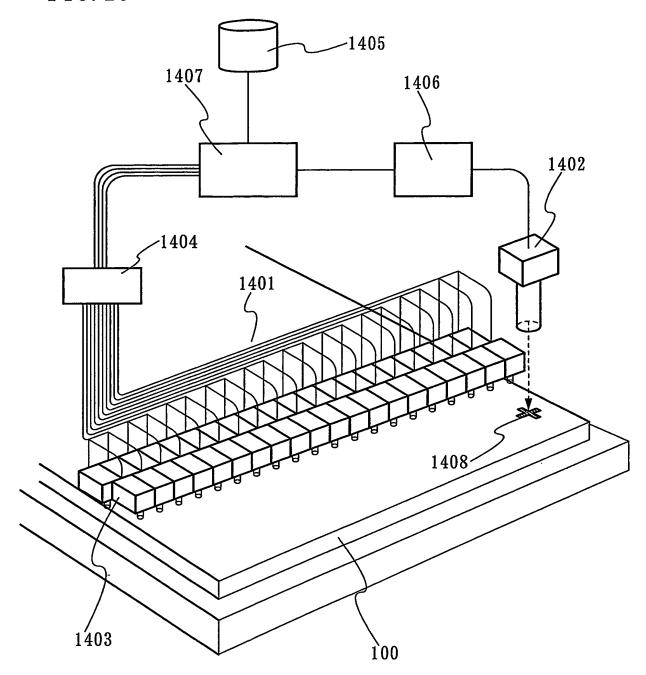


FIG. 25



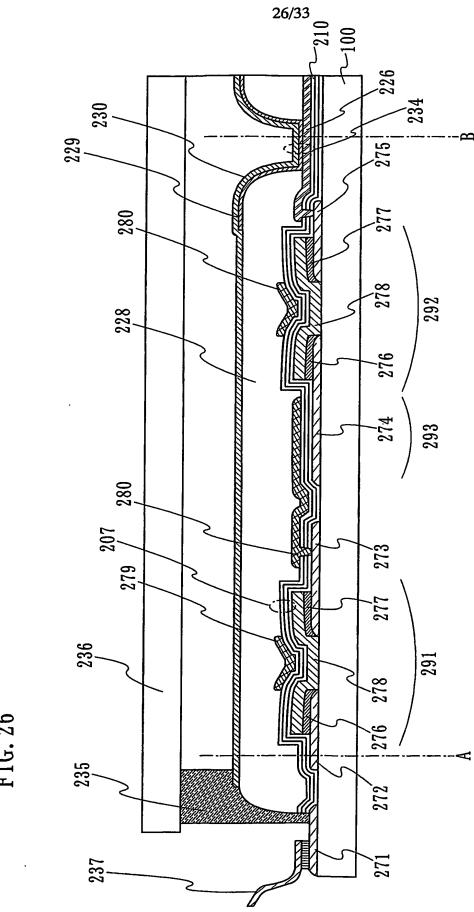


FIG. 27

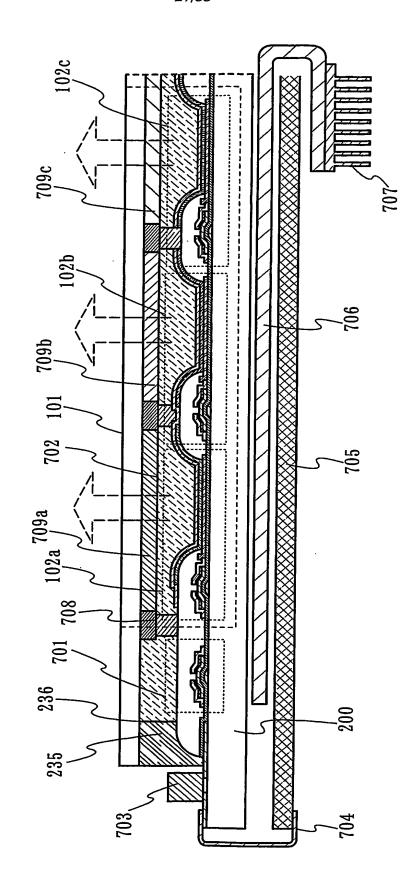


FIG. 28

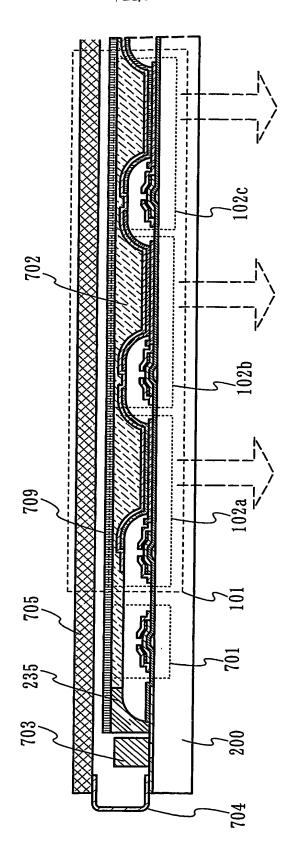
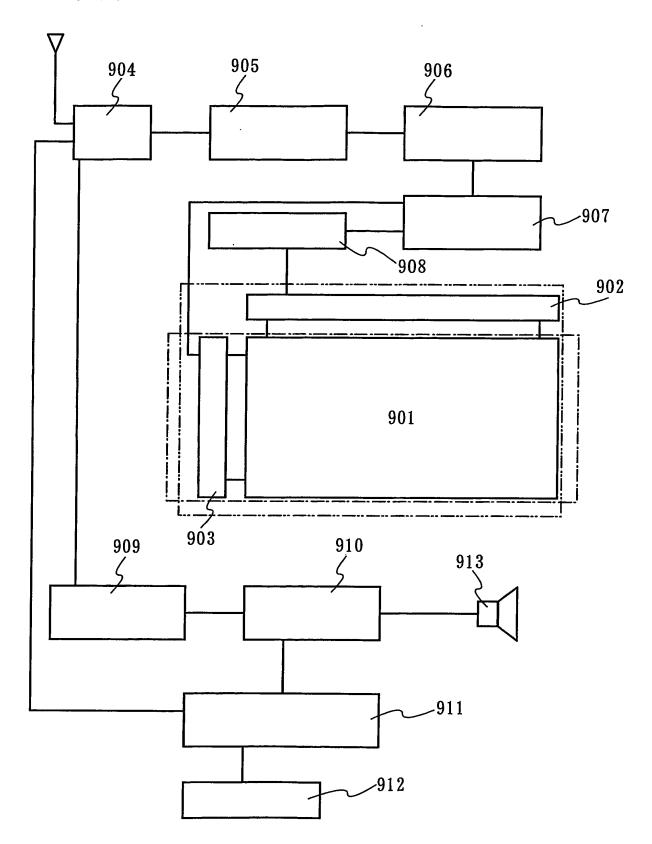


FIG. 29



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FIG. 30

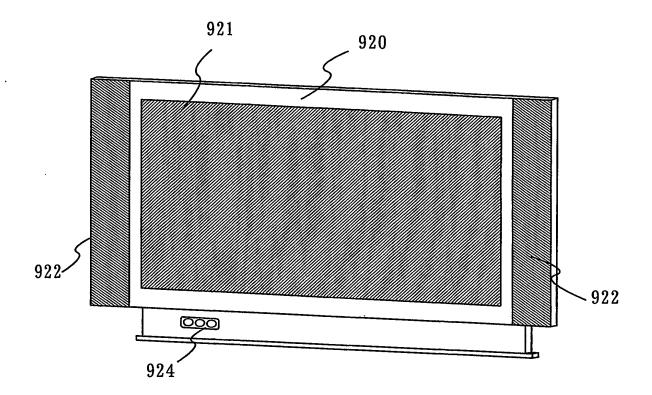


FIG. 31

